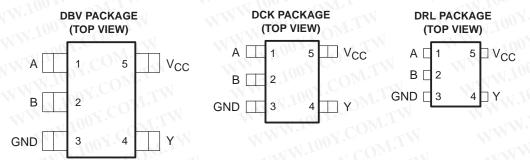
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- Operating Range of 2 V to 5.5 V
- Max t_{pd} of 7 ns at 5 V
- Low Power Consumption, 10-μA Max I_{CC}
- ±8-mA Output Drive at 5 V
- Schmitt-Trigger Action at All Inputs Makes the Circuit Tolerant for Slower Input Rise and Fall Time
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



See mechanical drawings for dimensions.

description/ordering information

The SN74AHC1G08 is a single 2-input positive-AND gate. The device performs the Boolean function $Y = A \bullet B$ or $Y = \overline{A} + \overline{B}$ in positive logic.

ORDERING INFORMATION

T _A	PACKAG	ÉT	ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
N.	1003	Reel of 3000	SN74AHC1G08DBVR	M.
	SOT (SOT-23) – DBV	Reel of 250	SN74AHC1G08DBVT	A08_
-40°C to 85°C	207 (20 70) POK	Reel of 3000	SN74AHC1G08DCKR	WILL
	SOT (SC-70) – DCK	Reel of 250	SN74AHC1G08DCKT	AE_
	SOT (SOT-553) - DRL	Reel of 4000	SN74AHC1G08DRLR	AE_

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

	INP	UTS	OUTPUT
Т	Α	В	Υ
1	Н	НС	D. H
	L	X	COVE
	X	105	LIT

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logic diagram (positive logic)





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TEXAS INSTRUMENTS

[‡] The actual top-side marking has one additional character that designates the assembly/test site.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	0.5 V to 7 V
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ _{JA} (see Note 2): DBV package	206°C/W
DCK package	252°C/W
DRL package	142°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum rated conditions for outer devices. implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

	W.Ing COM.	COM.	MIN MAX	UNIT	
VCC	Supply voltage	M. 100 . COM: I.	2 5.5	V.	
	WWW. 100Y. CO. TW	V _{CC} = 2 V	1.5	1	
۷ıн	High-level input voltage	V _{CC} = 3 V	2.1	V	
	W.100 F. COW. I.	V _{CC} = 5.5 V	3.85	WW	
V _{IL} Low-level input voltage	M. 1001. CONT. I.M.	V _{CC} = 2 V	0.5		
	Low-level input voltage	V _{CC} = 3 V	0.9	V	
	WWW.rc OV.COM.	V _{CC} = 5.5 V	1.65	W	
VI	Input voltage	TIWW.I	0 5.5	V	
٧o	Output voltage	W.100 F	0 Vcc	V	
	MM. 100X.	V _{CC} = 2 V	-50	μΑ	
IОН	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	-4	4	
	CON CON	$V_{CC} = 5 V \pm 0.5 V$	CO8	mA	
	W.1001.	V _{CC} = 2 V	50	μΑ	
loL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	4		
	MMM. OOX.CO	$V_{CC} = 5 V \pm 0.5 V$	8	mA	
Δt/Δv Inp	land the model on vice on fell sets	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	CO 100		
	Input transition rise or fall rate	$V_{CC} = 5 V \pm 0.5 V$	20	ns/V	
TA	Operating free-air temperature	N.T.	-40 85	°C	

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

WW.Io	COMP. CAN STAN M. P. CA. C.	Day.	T _A = 25°C			V.C.) I I I	W
PARAMETER	TEST CONDITIONS	, vcc	MIN	TYP	MAX	MIN	MAX	UNIT
W W 100	W.TW W. 1001.	2 V	1.9	2	atw.1	1.9	coM	. 1
	I _{OH} = -50 μA	3 V	2.9	3	11	2.9	-01	
Vон	W.COM.	4.5 V	4.4	4.5	MA	4.4		V
TWW.1	I _{OH} = -4 mA	3 V	2.58	-	WWW	2.48	$^{\checkmark}$.C $^{\circ}$	
	I _{OH} = -8 mA	4.5 V	3.94		WIN	3.8	~JC	
MAG	100X. OM.TH	2 V	TA		0.1	W.10	0.1	MO.
	I _{OL} = 50 μA	3 V	TN		0.1	- 1	0.1	
VOL VIVI	N.T. COM. THE WAY.	4.5 V	TV		0.1	Mar.	0.1	V
02	I _{OL} = 4 mA	3 V)Mr.	N	0.36	WW	0.44	
	I _{OL} = 8 mA	4.5 V	$O_{M^{*}I}$	- 1	0.36		0.44	
II W	V _I = 5.5 V or GND	0 V to 5.5 V	MOD	LA	±0.1	AA .	±1	μΑ
lcc 🕥	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V		TW	1	MA	10	μΑ
Ci	V _I = V _{CC} or GND	5 V	Con	4	10	W	10	pF

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

	FROM	то оитрит		T _A = 25°C				MAIN	200	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT	
^t PLH	W. 10	D. COMIT.	COMIT	111	100	6.2	8.8	1	10.5	WW.
^t PHL	A or B	OVICY	$C_L = 15 pF$	N.100	6.2	8.8	1	10.5	ns	
^t PLH	A or B	ON CONTRACTOR	C: FO.DE	100	8.7	12.3	1	14	////	
^t PHL	AUIB	TOOM.	Y C _L = 50 pF	M.r.	8.7	12.3	1	14	ns	

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

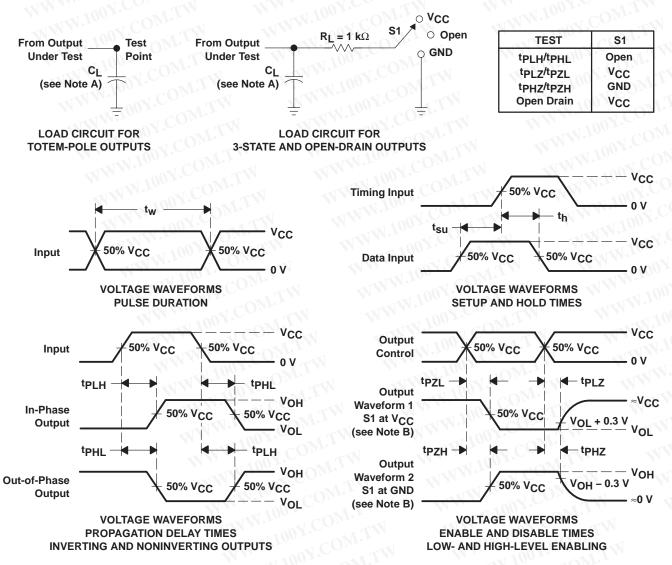
DADAMETED	FROM	то	OUTPUT	$T_A = 25^{\circ}C$		MAX						
PARAMETER	(INPUT)	(OUTPUT)	OUTPUT) CAPACITANCE		MAX		MIN	UNIT				
t _{PLH}	A - :: D	1001.	45	4.3	5.9	01/1	7					
^t PHL	A or B	Y	C _L = 15 pF	CL = 15 pF	CL = 15 pF	CL = 15 pF	CL = 15 pr	4.3	5.9	1	7	ns
^t PLH	A or B	WW.	C: - 50 pF	5.8	7.9	1	9	200				
t _{PHL}	AUIB	111111111111111111111111111111111111111	C _L = 50 pF	5.8	7.9		9	ns				

operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load, f = 1 MHz	18	pF



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 3 ns. $t_f \leq$ 3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms





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PACKAGE OPTION ADDENDUM

10-Oct-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	n MSL Peak Temp ⁽³⁾
SN74AHC1G08DBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DBVRE4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DBVTE4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DCKR	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DCKRE4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DCKRG4	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DCKT	ACTIVE	SC70	DCK	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DCKTE4	ACTIVE	SC70	DCK	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DRLR	ACTIVE	SOP	DRL	5	4000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC1G08DRLRG4	ACTIVE	SOP	DRL	5	4000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

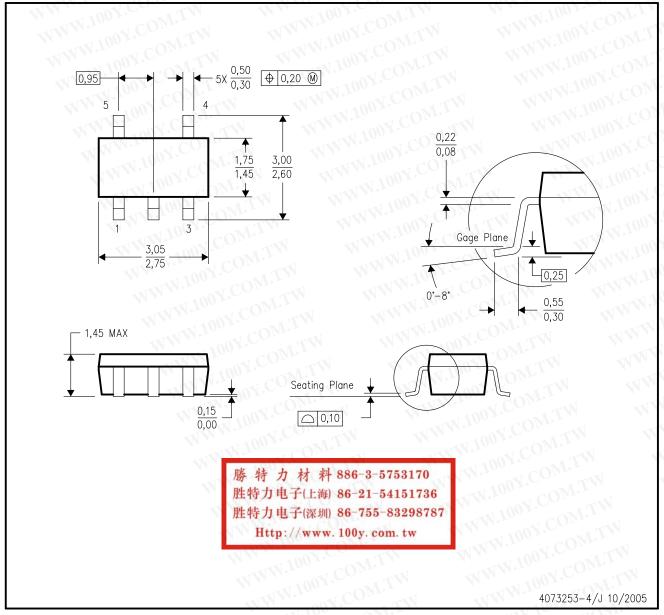
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



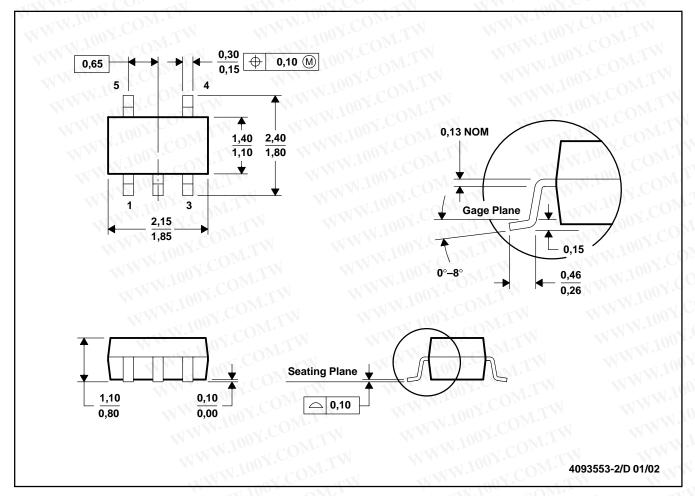
NOTES:

- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-178 Variation AA.



DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



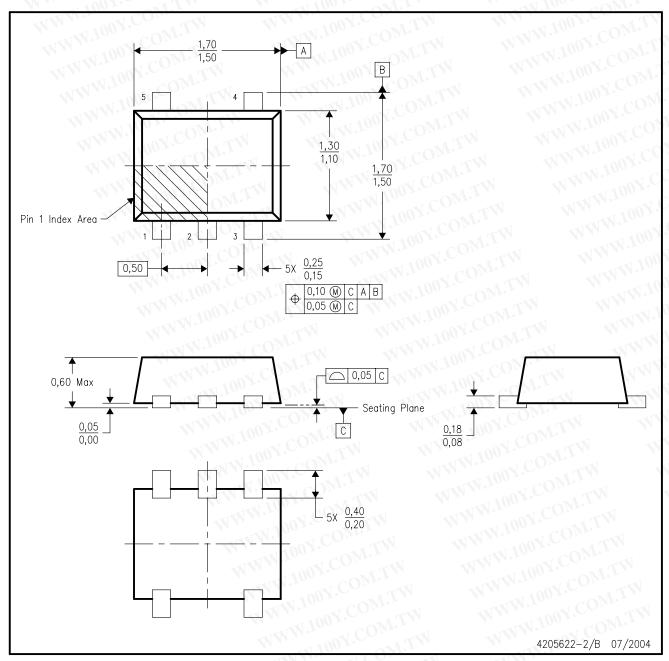
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-203



DRL (R-PDSO-N5)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. JEDEC package registration is pending.



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